



DUAL SURFACE MOUNT LOW LEAKAGE DIODE

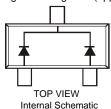
Features

- Surface Mount Package Ideally Suited for Automated Insertion
- Very Low Leakage Current
- Lead, Halogen and Antimony Free, RoHS Compliant
- "Green" Device (Notes 3 and 4)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT-23
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Polarity: See Diagram
- Marking Information: See page 2
- Ordering Information: See Page 2
- Weight: 0.008 grams (approximate)

TOP VIEW



Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	V		
RMS Reverse Voltage		V _{R(RMS)}	60	V
Forward Continuous Current (Note 1) Single Diode Double Diode		I _{FM}	215 125	mA
Repetitive Peak Forward Current		I _{FRM}	500	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0µs @ t = 1.0ms @ t = 1.0s	I _{FSM}	4.0 1.0 0.5	А

SOT-23

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 1)	PD	250	mW
Thermal Resistance Junction to Ambient Air (Note 1)	R _{0JA}	500	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 2)	V _{(BR)R}	85	_	_	V	I _R = 100μA
Forward Voltage	VF	_	_	0.90 1.0 1.1 1.25	V	$I_{F} = 1.0mA$ $I_{F} = 10mA$ $I_{F} = 50mA$ $I_{F} = 150mA$
Leakage Current (Note 2)	I _R	_	_	5.0 80	nA nA	V _R = 75V V _R = 75V, T _J = 150°C
Total Capacitance	CT	_	2	_	pF	V _R = 0, f = 1.0MHz
Reverse Recovery Time	t _{rr}	_	_	3.0	μs	$I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \text{ x } I_R, R_L = 100 \Omega$

Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf. 1. 2

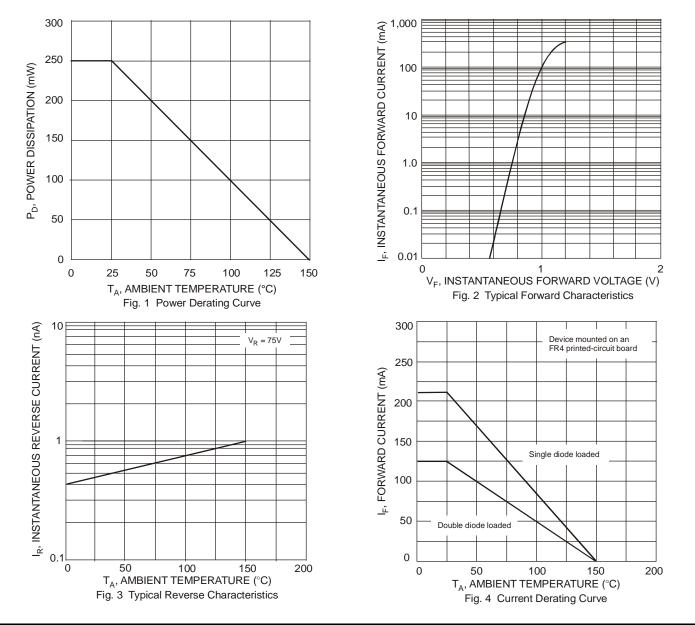
Short duration pulse test used to minimize self-heating effect. No purposefully added lead. Halogen and Antimony Free.

3.

Product manufactured with Data Code V9 (week 33, 2008) and newer are built with Green Molding Compound. Product manufactured prior to Date 4. Code V9 are built with Non-Green Molding Compound and may contain Halogens or Sb₂O₃ Fire Retardants.

Notes:



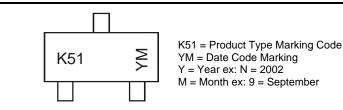


Ordering Information (Note 5)

Part Number	Case	Packaging
BAV170-7-F	SOT-23	3000/Tape & Reel

Notes: 5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

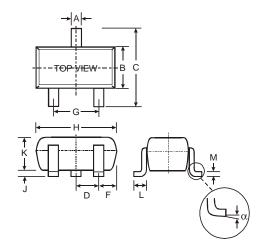
Marking Information



Date Code Key	-						-	-	-	-	-	
Year	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	М	Ν	Р	R	S	Т	U	V	W	Х	Y	Z
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

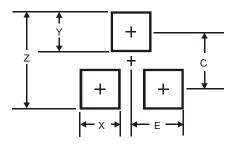


Package Outline Dimensions



SOT-23					
Dim	Min	Max			
Α	0.37	0.51			
В	1.20	1.40			
С	2.30	2.50			
D	0.89	1.03			
F	0.45	0.60			
G	1.78	2.05			
Н	2.80	3.00			
J	0.013	0.10			
К	0.903	1.10			
L	0.45	0.61			
М	0.085	0.180			
α	0°	8°			
All Dir	nensions	in mm			

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Y	0.9
С	2.0
E	1.35

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